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US D452,220 S ** Dec. 18, 2001 (45) Date of Patent: Robson

ARRANGEMENT OF ALUMINUM FOIL COILS FORMING AN INDUCTOR OF A RESONANT FREQUENCY IDENTIFICATION **ELEMENT**

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(DE)

(**) Term: 14 Years

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Related U.S. Application Data

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(30)Foreign Application Priority Data

Oct.	15, 1998	(DE)	••••••••••••	498 10 255	
(51)	LOC (7)	Cl	••••••	13-03	
(52)	U.S. Cl.	• • • • • • • • • • • • • • • • • • • •	• • • • • • • • • • • • • • • • • • • •	D13/182	
(58)	Field of	Search			
			336/20, 200, 21	2; 340/572	

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Primary Examiner—Brian N. Vinson (74) Attorney, Agent, or Firm—Jones, Tullar & Cooper, P.C.

(57)**CLAIM**

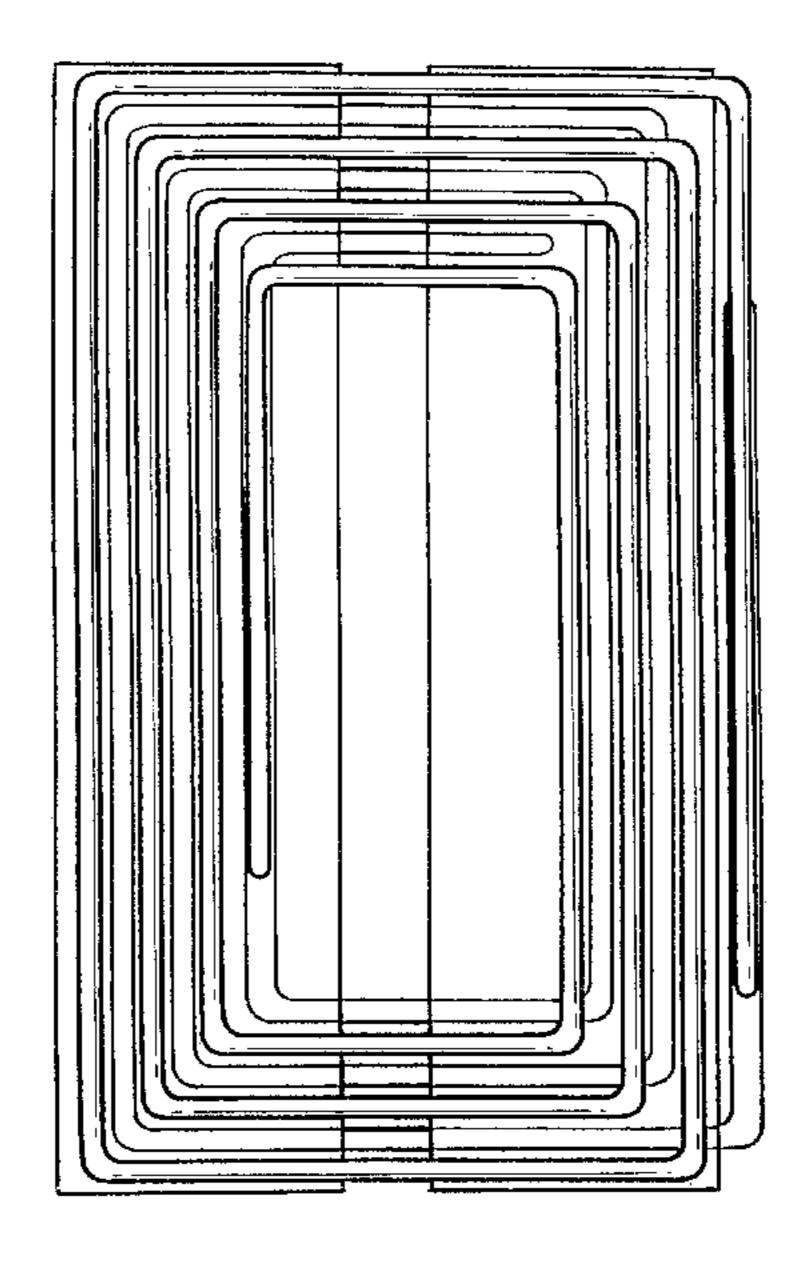
The ornamental design for an arrangement of aluminum foil coils forming an inductor of a resonant frequency identification element, as shown and described.

DESCRIPTION

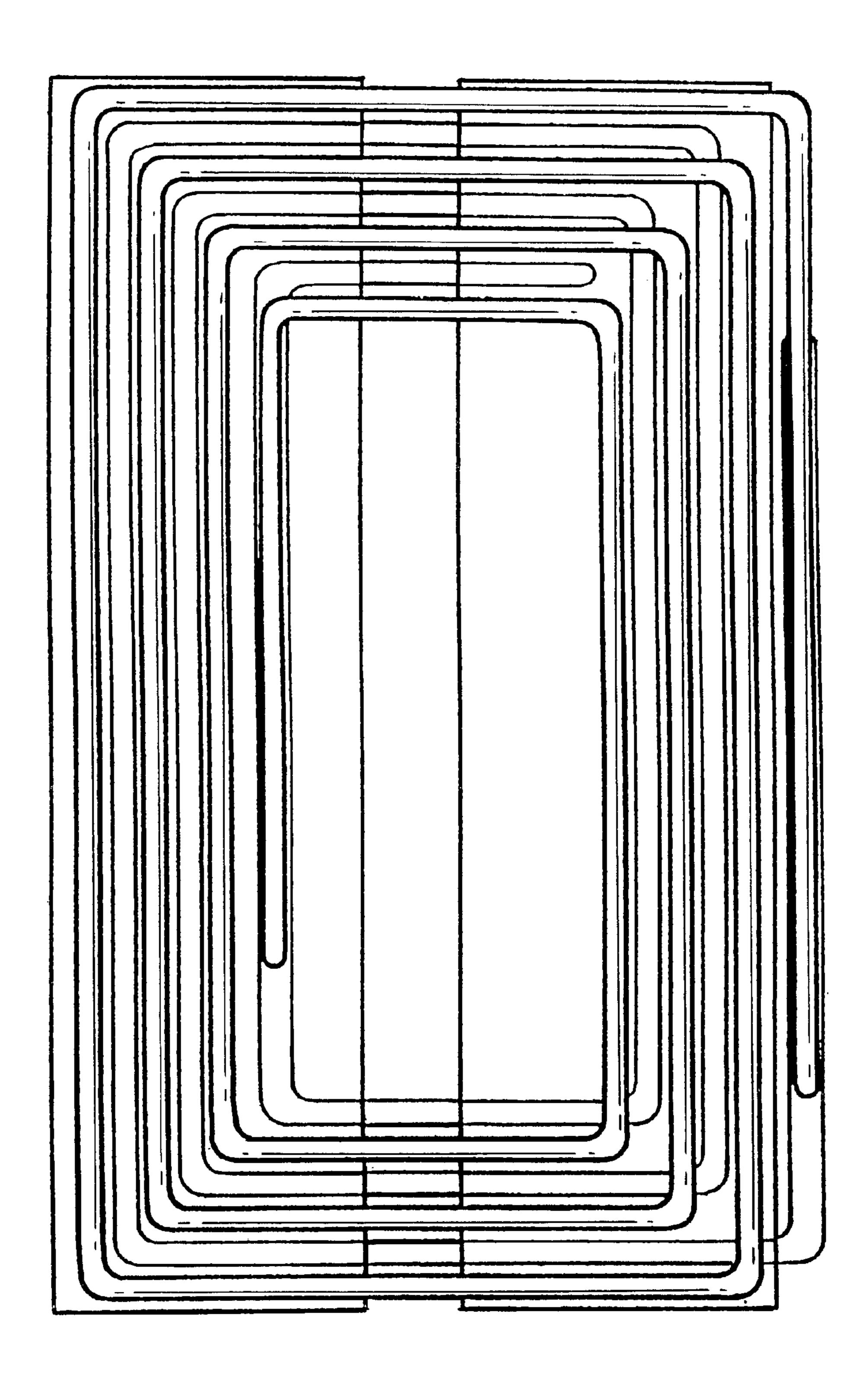
- FIG. 1 is a top view of the arrangement of aluminum foil coils forming an inductor of the resonant frequency indentification of the present invention;
- FIG. 2 is a bottom view of the arrangement of FIG. 1;
- FIG. 3 is a top view of the arrangement of aluminum foil coils mounted on a chip dimensioned differently from the arrangement of FIGS. 1 and 2;
- FIG. 4 is a bottom view of the arrangement of FIG. 3;
- FIG. 5 is a top view of another arrangement of aluminum foil coils mounted on a chip;
- FIG. 6 is a bottom view of the arrangement of FIG. 5;
- FIG. 7 is a top view of an arrangement of aluminum foil coils mounted on a chip dimensioned differently from the arrangement of FIGS. 1, 2, 3, 4 and 5;
- FIG. 8 is a bottom view of the arrangement of FIG. 5;
- FIG. 9 is a top view of another arrangment of aluminum foil coils mounted on a chip;
- FIG. 10 is a bottom view of the arrangement of FIG. 9;
- FIG. 11 is a top view of an arrangement of aluminum foil coils mounted on a chip dimensioned differently from the arrangement of FIGS. 9 and 10; and,
- FIG. 12 is a bottom view of the arrangement of FIG. 11.

The arrangement of coils is of nominal thickness.

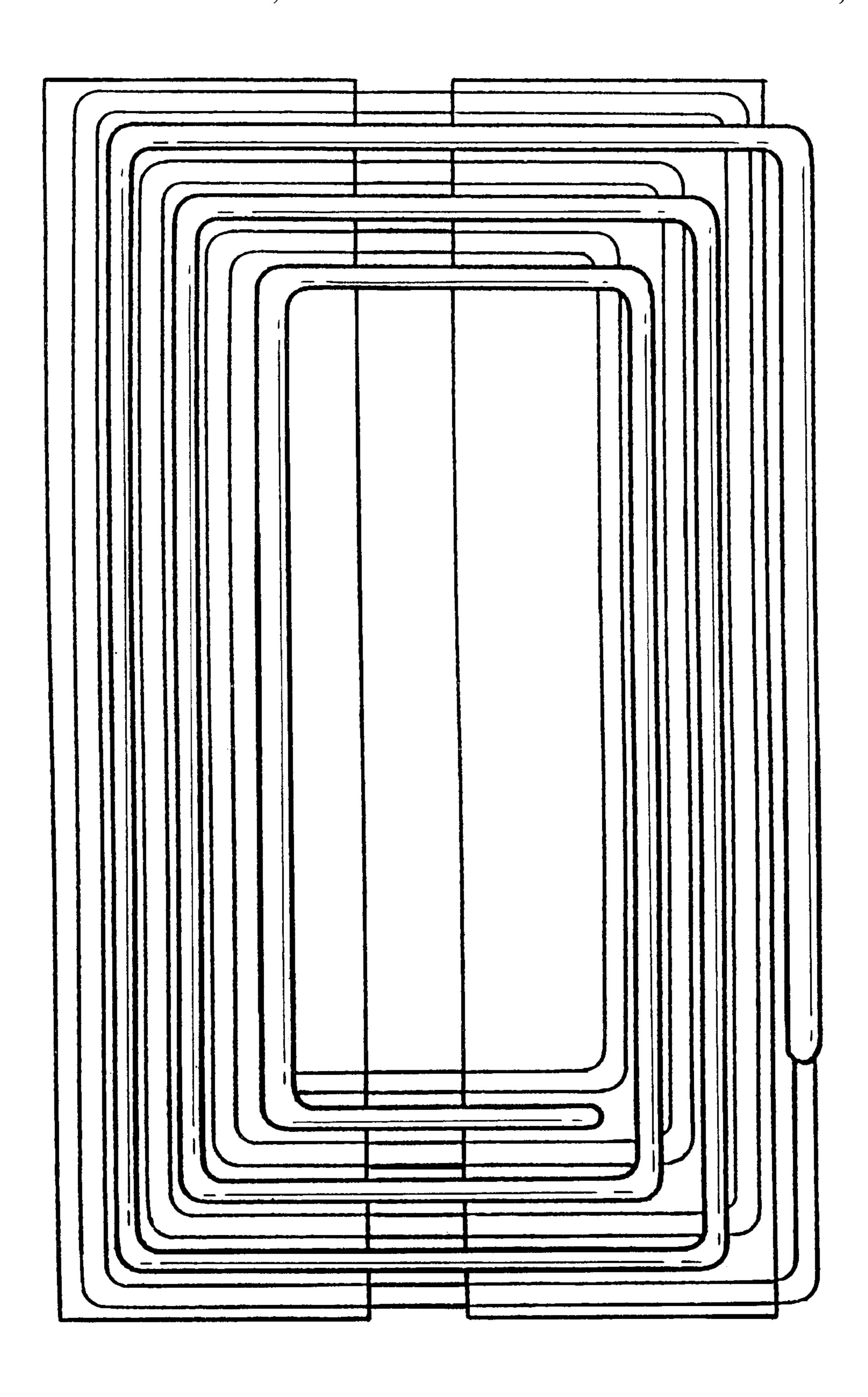
1 Claim, 12 Drawing Sheets



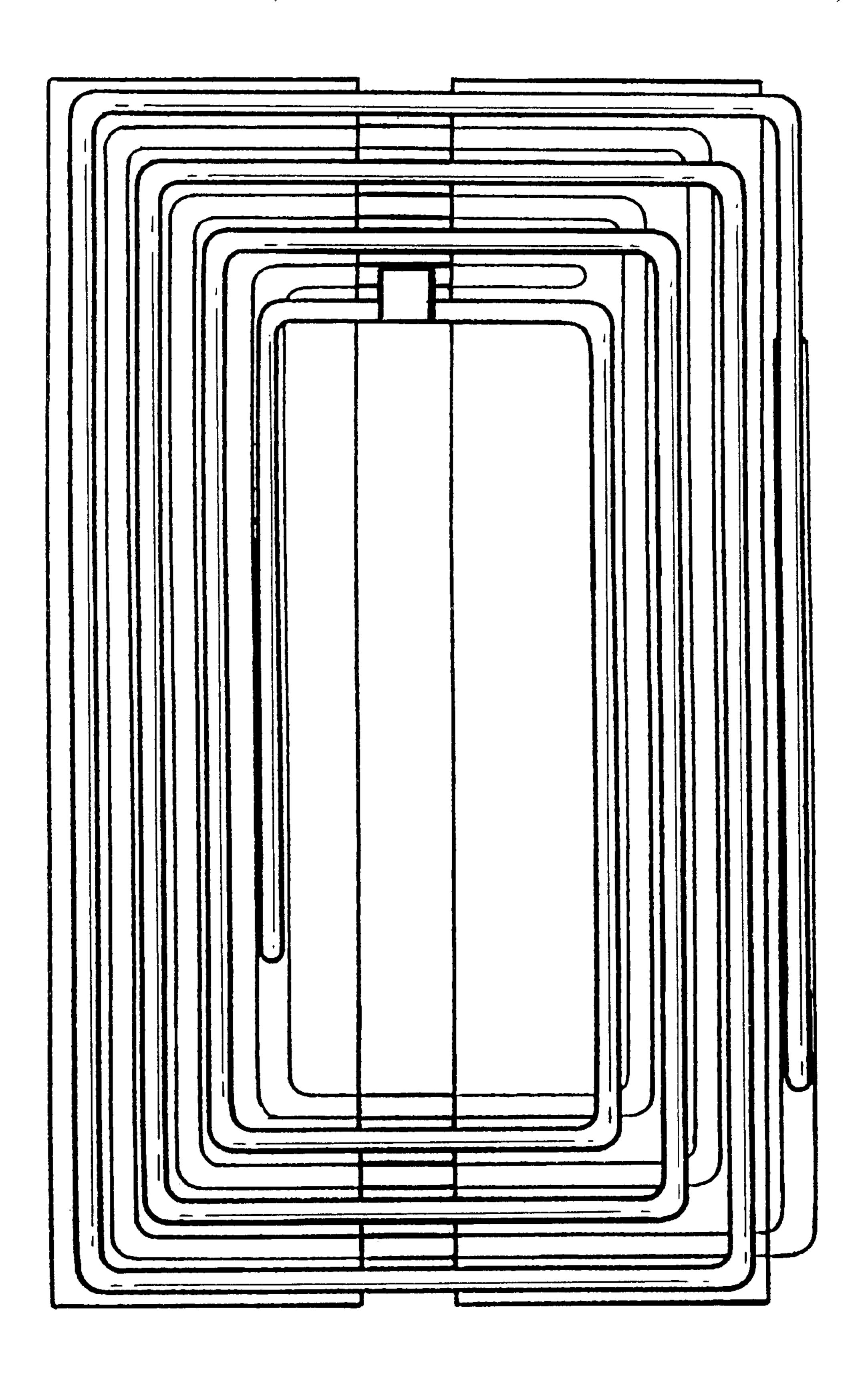
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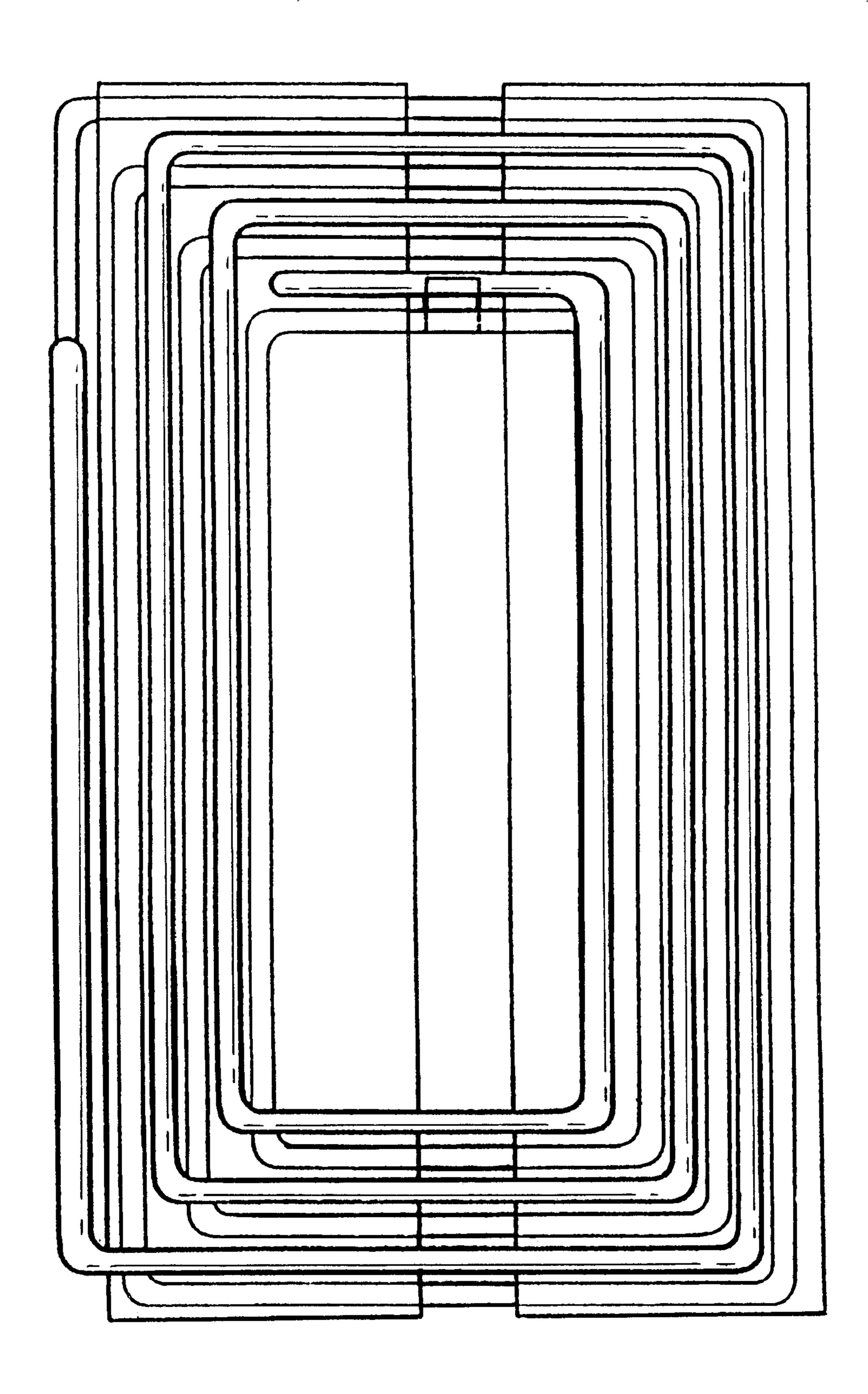
F1G.1



F16.2

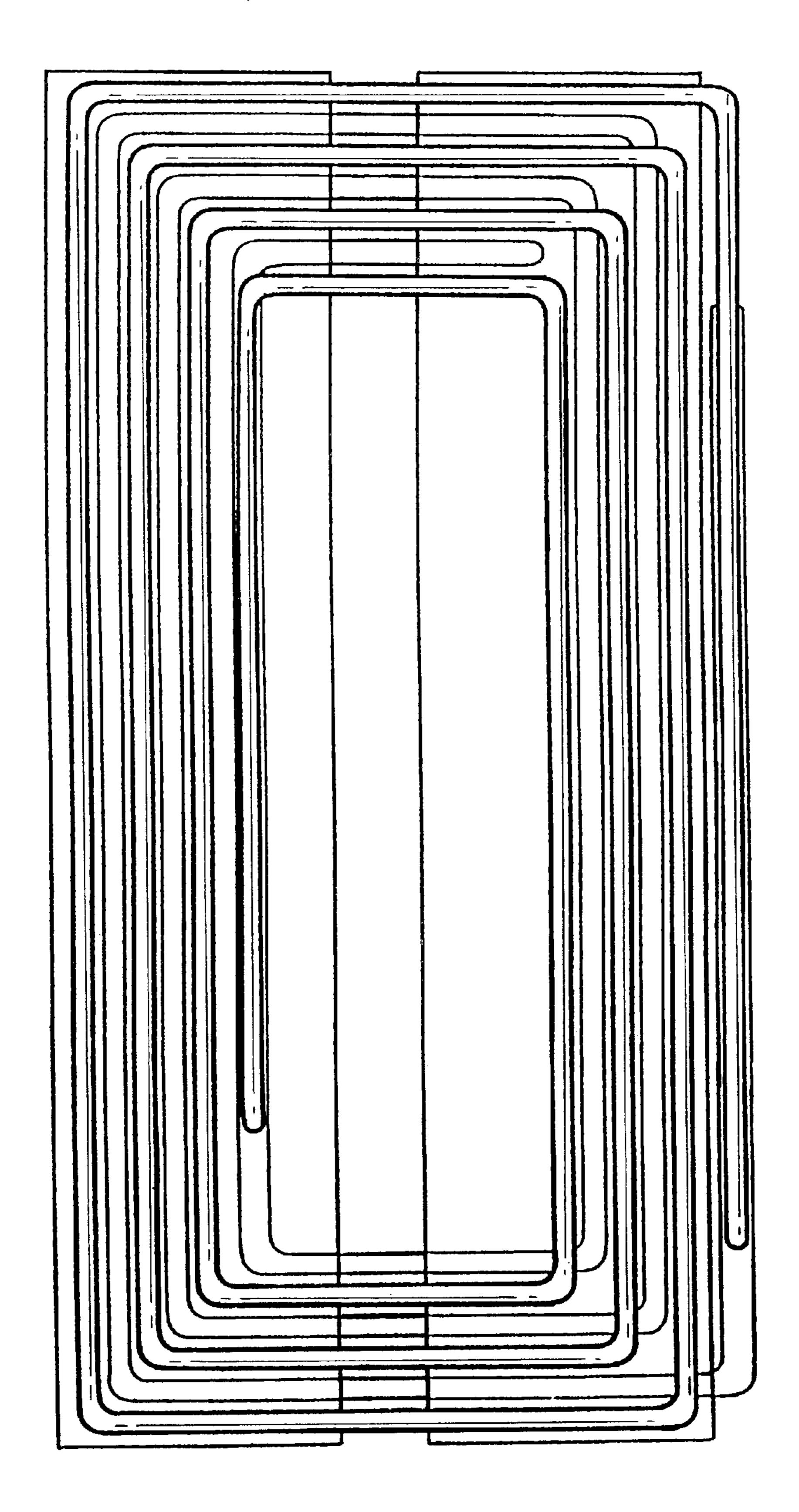


F16.3

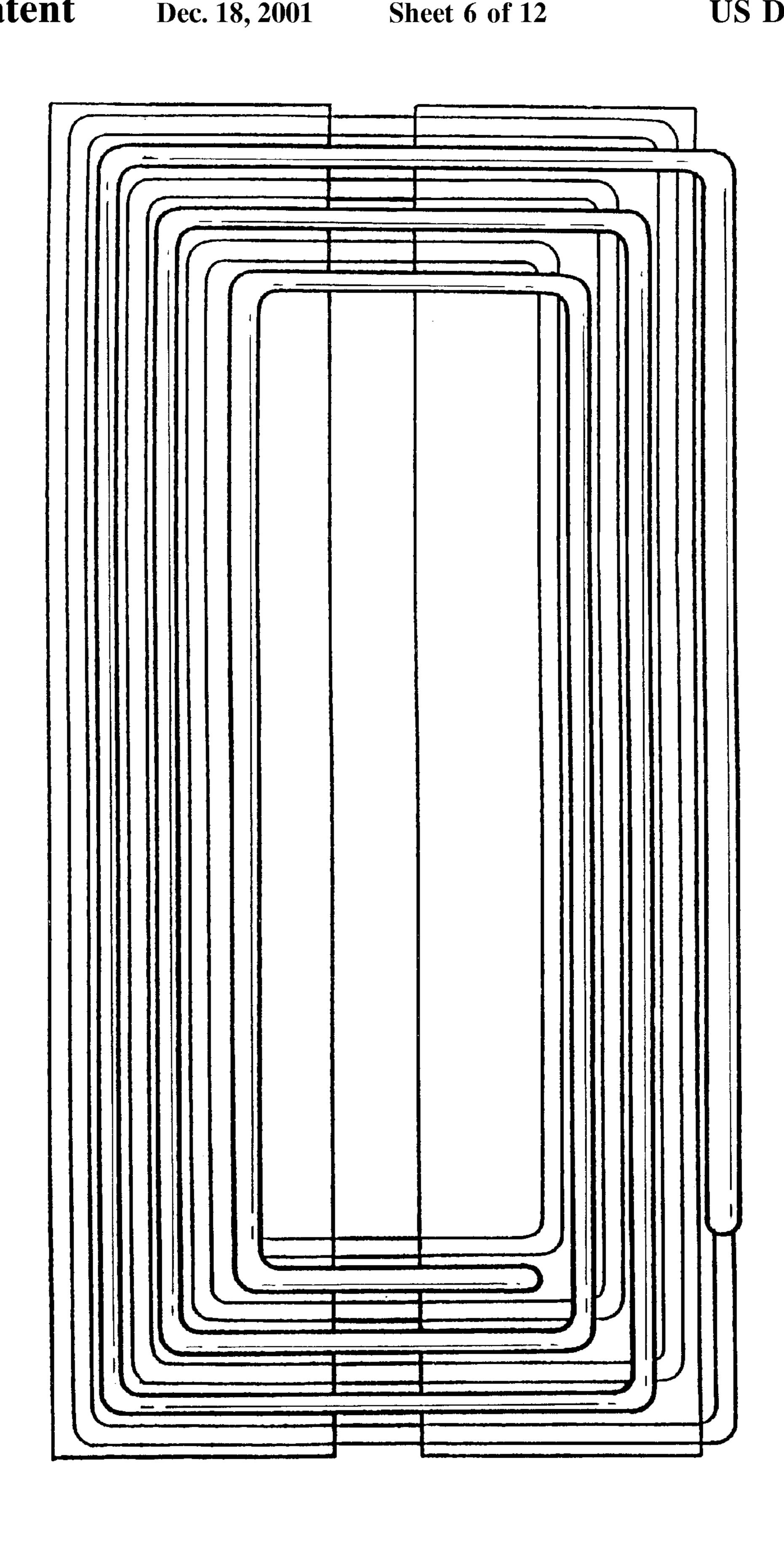


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Dec. 18, 2001



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Dec. 18, 2001

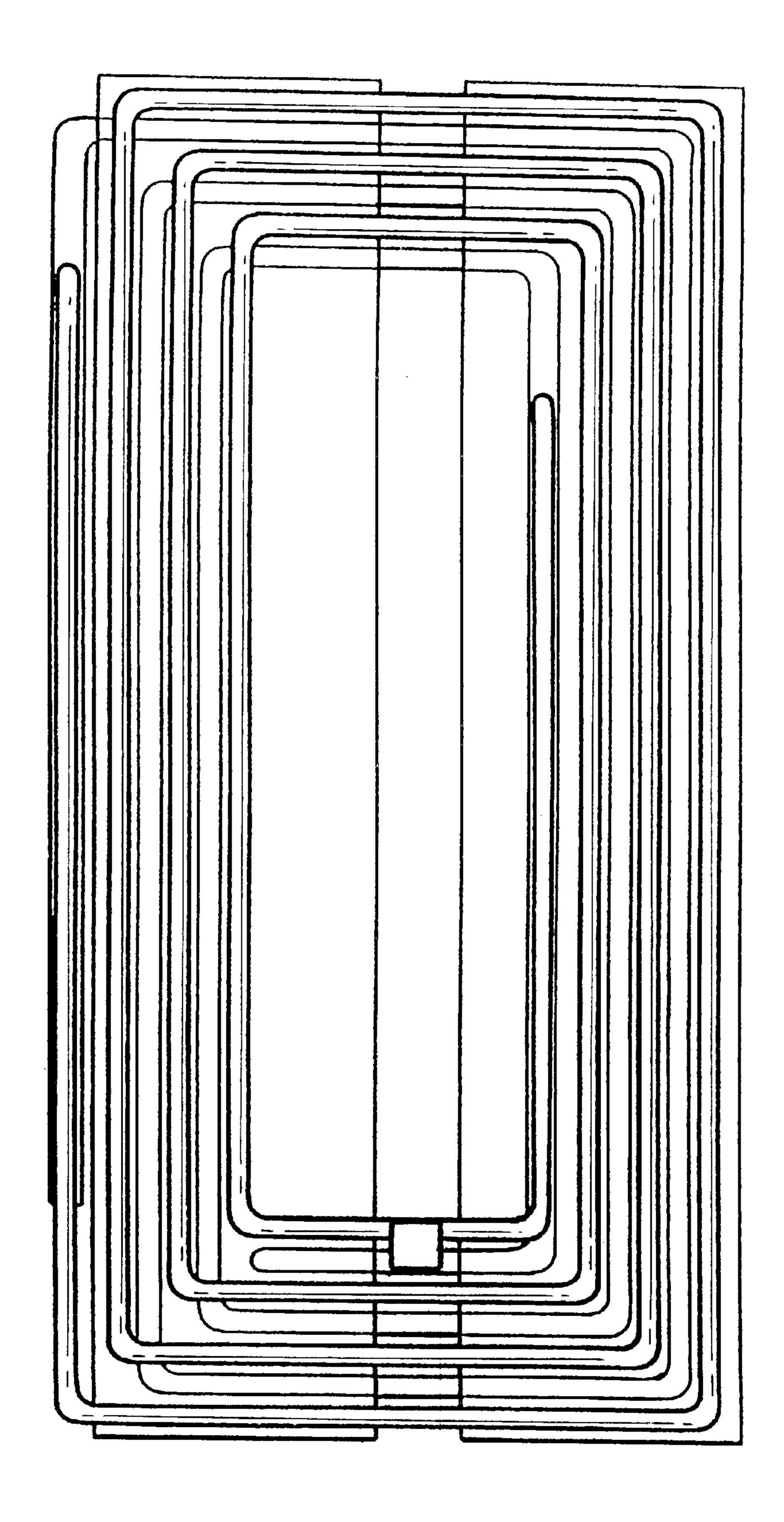
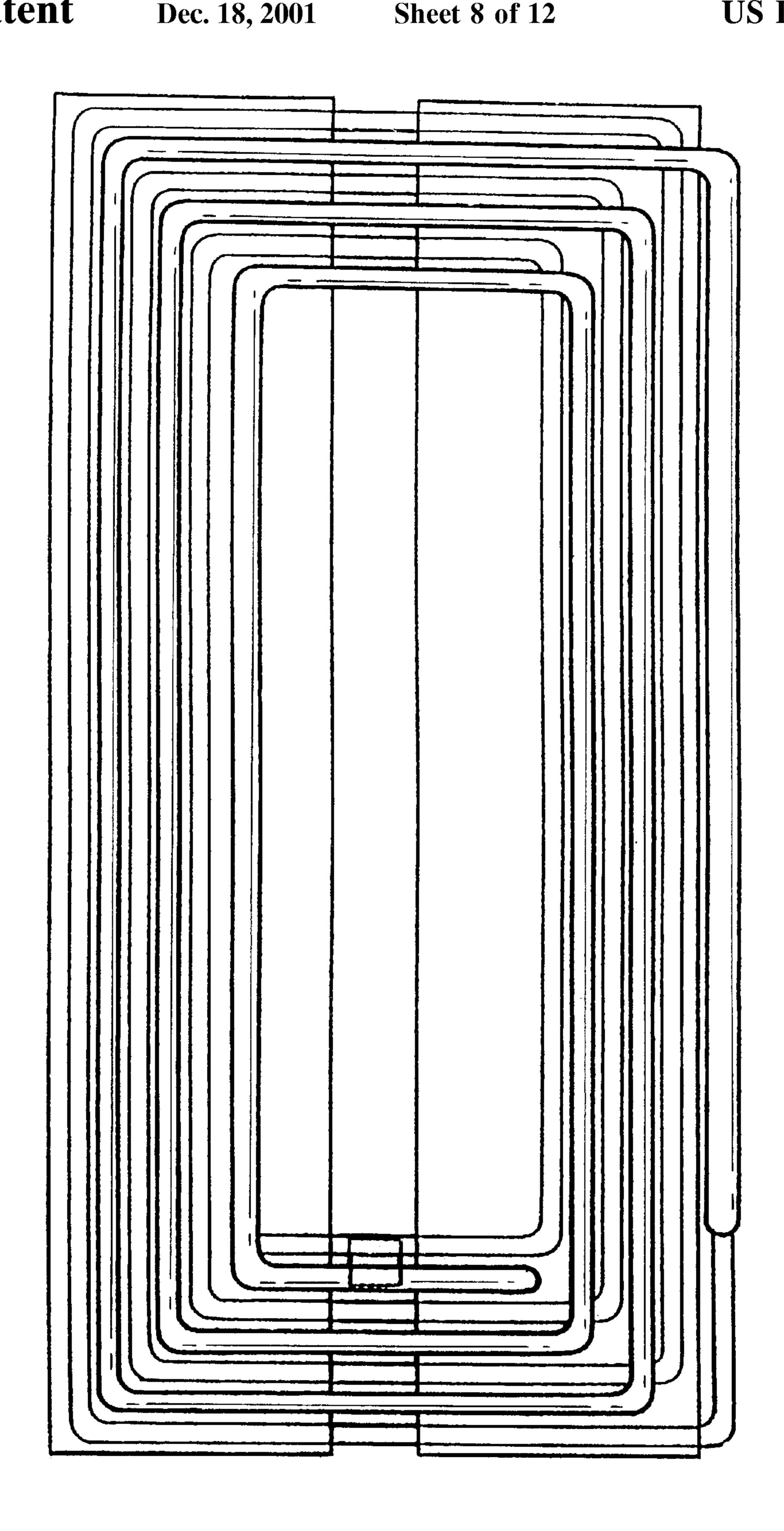
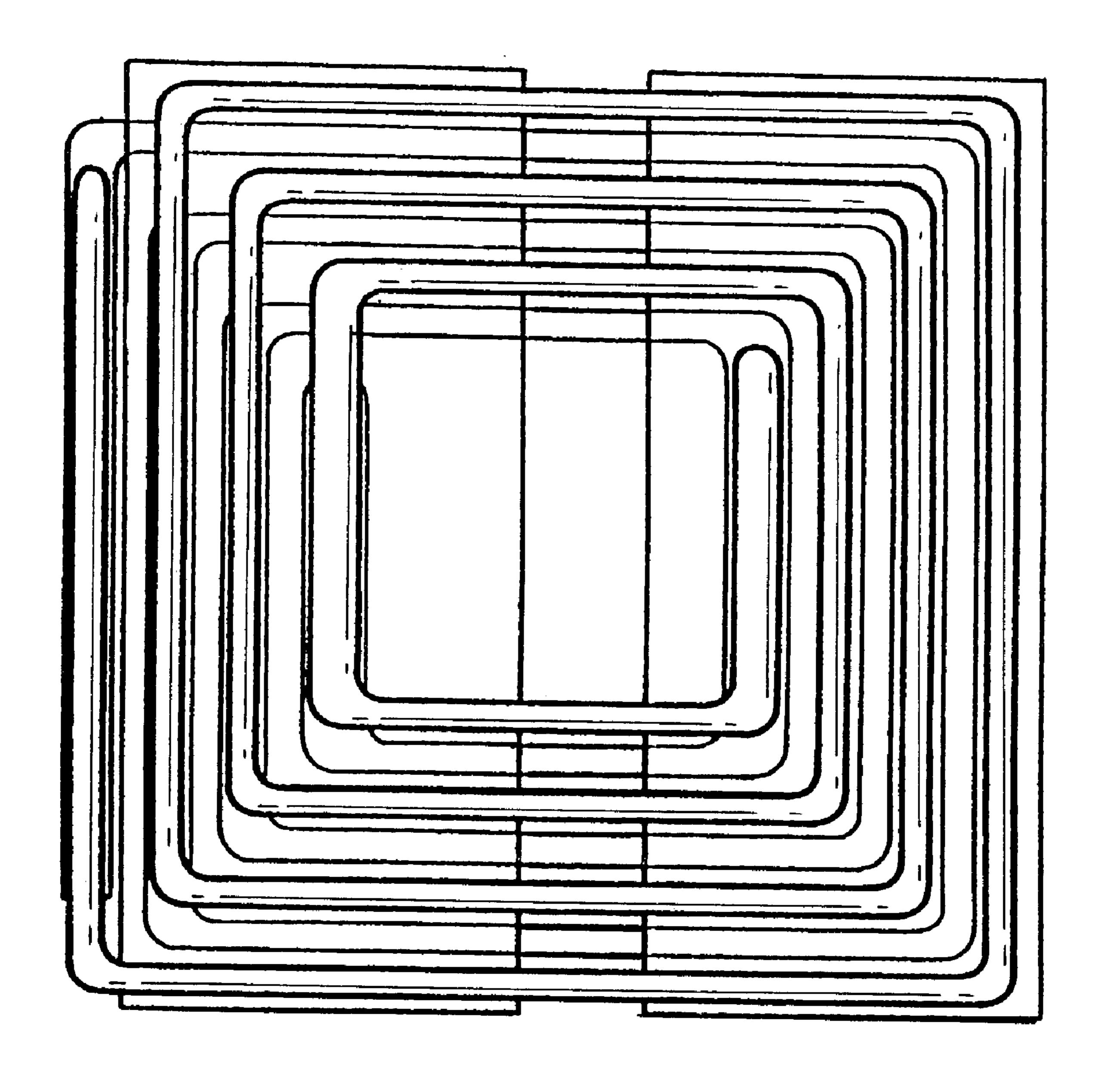


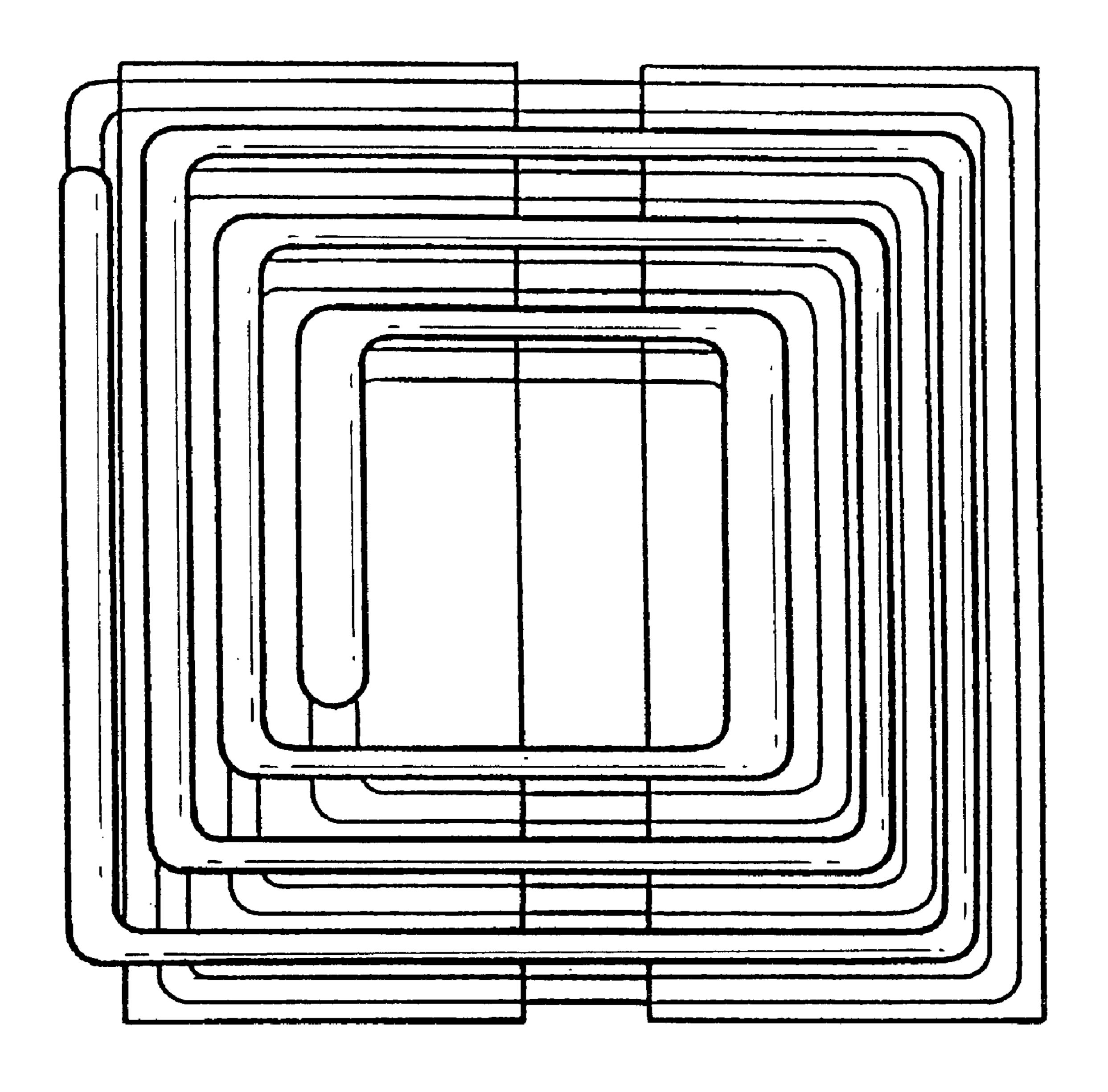
FIG. 7



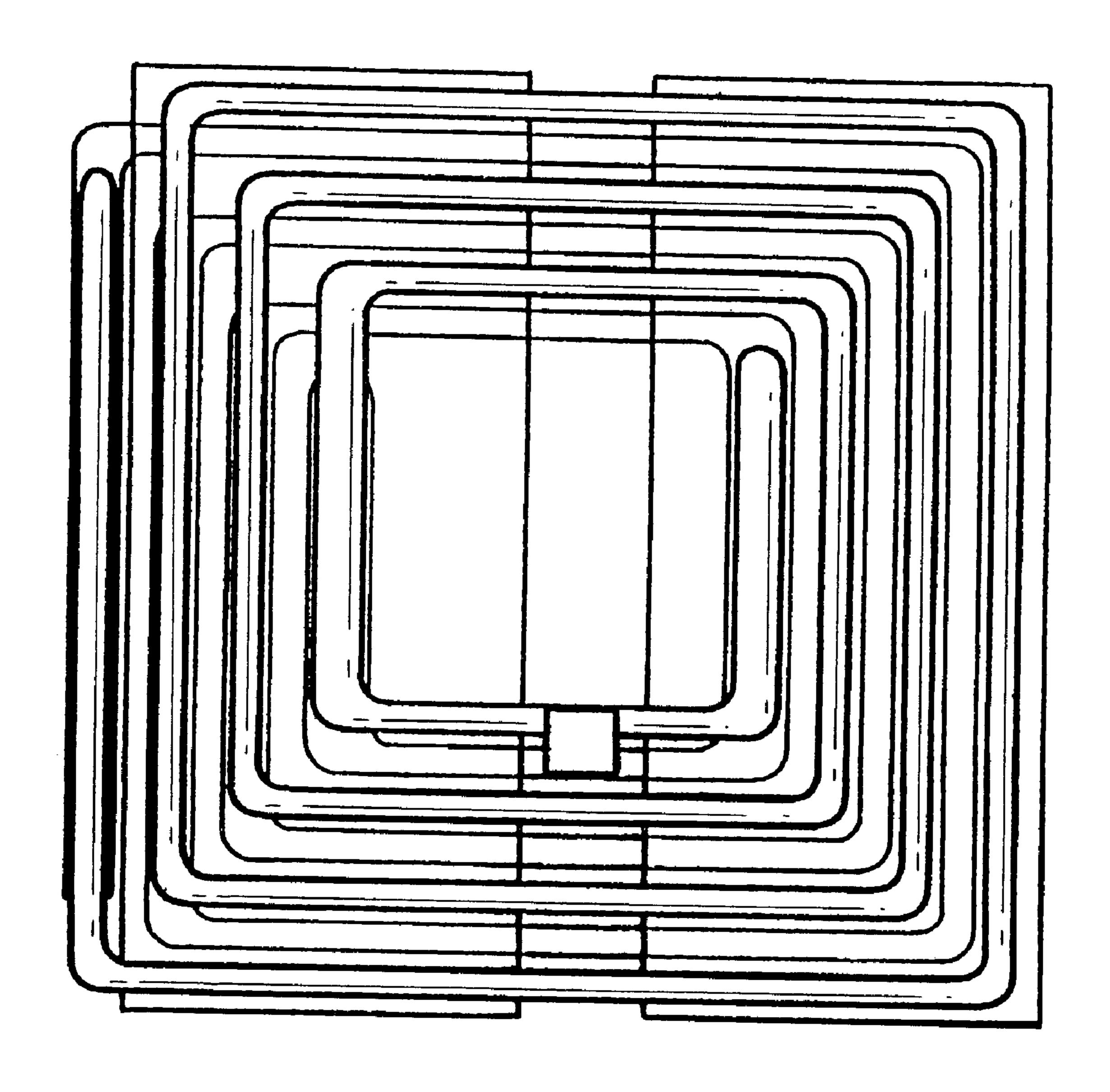
F16.8



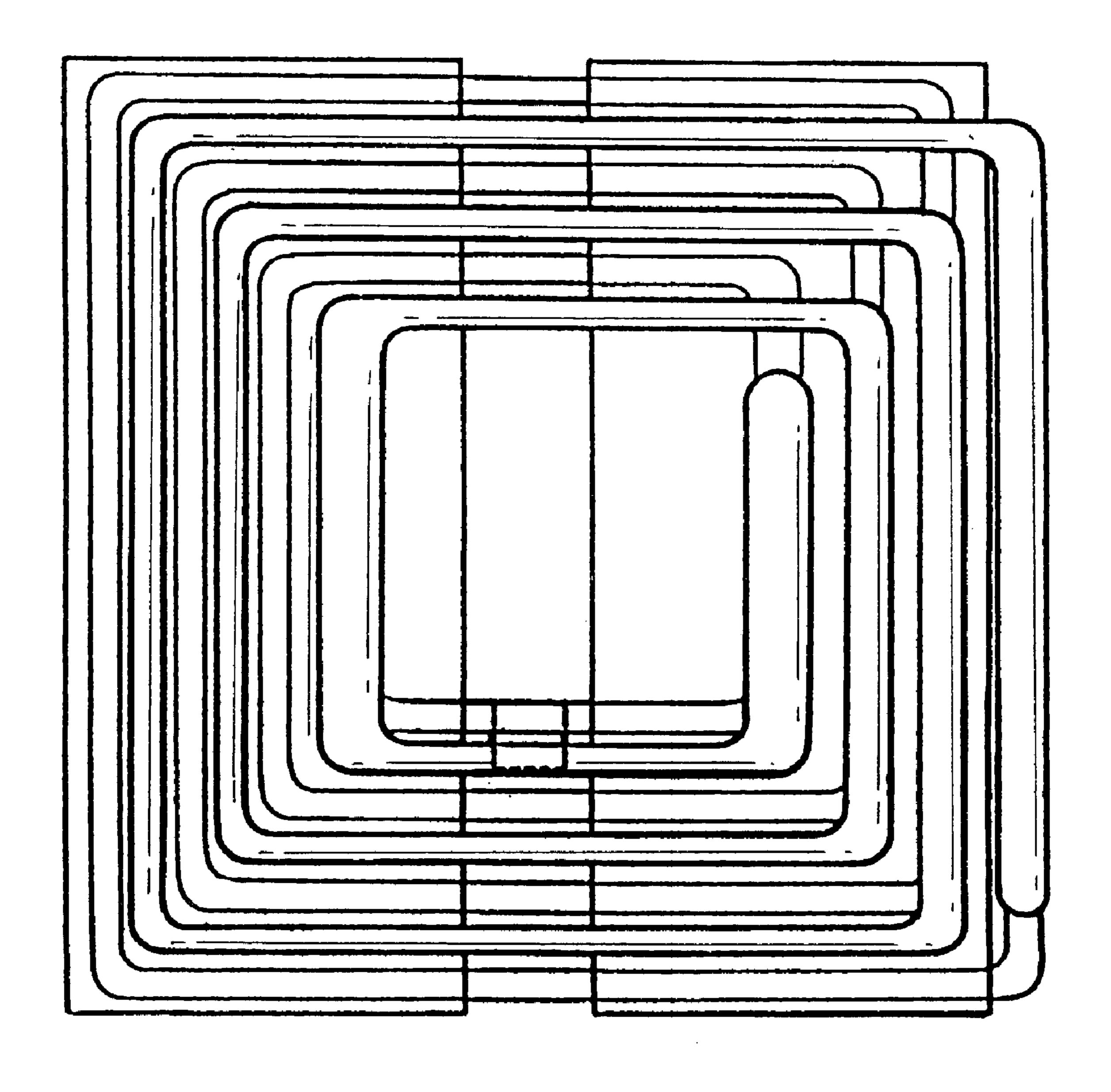
F16.9



F16.10



F 1 G. 11



F16.12